

**AMENDMENTS TO THE SPECIFICATION:**

Please amend the specification as follows:

Please replace the below-numbered paragraphs with the following amended paragraphs:

[0011] To achieve the above objects, the resin substrate of ~~claim 1~~ has a resin-metal composite layer that metallic particles are dispersed in a resin matrix at a surface of the resin substrate.

[0012] The resin substrate having a resin-metal composite layer of ~~claim 2~~ comprises the resin substrate having the resin-metal composite layer ~~set forth in claim 1~~, wherein the resin-metal composite layer is from 20 to 2000 nm in thickness.

[0013] The resin substrate having a resin-metal composite layer of ~~claim 3~~ comprises the resin substrate having the resin-metal composite layer ~~set forth in claim 1~~, wherein the resin-metal composite layer is a transparent conductive layer of 200 nm or less than 200 nm in thickness.

[0014] The method for manufacturing a resin substrate having a resin-metal composite layer at a surface thereof in ~~claim 4~~ comprises a pretreatment process that a surface of the resin substrate is modified to a modified layer having a polar group, and an adsorbing process that at least either metal colloids or ions are adsorbed to the polar group by contacting the modified layer with a metal compound solution, whereby metal

particles are dispersed into the modified layer.

[0015] The method for manufacturing a resin substrate having a resin-metal composite layer of ~~claim 5~~ comprises the processes for manufacturing a resin substrate having a resin-metal composite layer ~~set forth in claim 4~~, wherein after the adsorbing process, a metal coating is formed on the surface of the refining layer by electroless plating, thereafter removing the metal coating.